



Part Number:101-00295-**

4-IN-1 Conn. Push Push (SD, MMC, MS, XD)

- Push push eject type
- SMT
- Application for notebook computers, printers, card readers

- 1.Materials:**
 Housing: High temperature thermoplastic, UL 94V-0 rated.
 Contact: Copper alloy
 Cover: Copper alloy, over weld nickel plating 40~80u"
- 2.Contact finish:**
 Selective 1~15u" gold plating on contact area, tin 160u" plating at solder tail, over nickel plating (50U" min)
- 3.Electrical specifications:**
 Voltage Rating: 250VAC
 Current Rating: 0.5A per contact
 Dielectric strength: 500VAC initial and 250VAC final for one minute
 Insulation Resistance: 1000MΩ min at 250VDC
 Contact Resistance: 100mΩ max
 Operating temperature: -20°C~+60°C
- 4.Mechanical specifications:**
 Durability: 10000 cycles.
 Mating force: 40N max.
 Unmating force: 2N min
- 5.RoHS Compliant**

